

Single P-channel MOSFET

ELM14411AA-N

■General description

ELM14411AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

■Features

- $V_{ds} = -30V$
- $I_d = -8A$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 32m\Omega$ ($V_{gs} = -10V$)
- $R_{ds(on)} < 55m\Omega$ ($V_{gs} = -4.5V$)

■Maximum absolute ratings

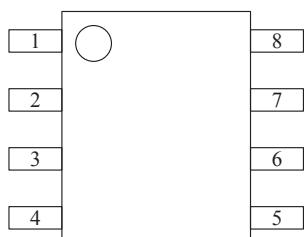
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	-30	V	
Gate-source voltage	V_{gs}	± 20	V	
Continuous drain current Ta=25°C	I_d	-8.0	A	1
Ta=70°C		-6.6		
Pulsed drain current	I_{dm}	-40	A	2
Power dissipation Ta=25°C	P_d	3.0	W	1
Ta=70°C		2.1		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	24	40	°C/W	1
Maximum junction-to-ambient	Steady-state		54	75	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	21	30	°C/W	3

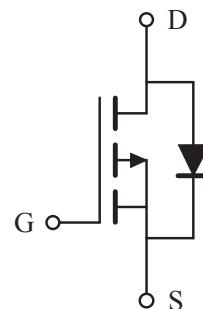
■Pin configuration

SOP-8(TOP VIEW)



Pin No.	Pin name
1	SOURCE
2	SOURCE
3	SOURCE
4	GATE
5	DRAIN
6	DRAIN
7	DRAIN
8	DRAIN

■Circuit



Single P-channel MOSFET

ELM14411AA-N

■Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BVdss	Id=-250µA, Vgs=0V	-30			V
Zero gate voltage drain current	Idss	Vds=-24V			-1	µA
		Vgs=0V	T _j =55°C		-5	
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			±100	nA
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250µA	-1.2	-2.0	-2.4	V
On state drain current	Id(on)	Vgs=-10V, Vds=-5V	-40			A
Static drain-source on-resistance	Rds(on)	Vgs=-10V		24.5	32.0	mΩ
		Id=-8A	T _j =125°C	33.0		
		Vgs=-4.5V, Id=-5A		41.0	55.0	mΩ
Forward transconductance	Gfs	Vds=-5V, Id=-8A		14.5		S
Diode forward voltage	Vsd	Is=-1A, Vgs=0V		-0.76	-1.00	V
Max. body-diode continuous current	Is				-4.2	A
DYNAMIC PARAMETERS						
Input capacitance	Ciss	Vgs=0V, Vds=-15V, f=1MHz		920	1120	pF
Output capacitance	Coss			190		pF
Reverse transfer capacitance	Crss			122		pF
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz		3.6	5.0	Ω
SWITCHING PARAMETERS						
Total gate charge (10V)	Qg	Vgs=-10V, Vds=-15V Id=-8A		18.4	23.0	nC
Total gate charge (4.5V)	Qg			9.3	11.5	nC
Gate-source charge	Qgs			2.7		nC
Gate-drain charge	Qgd			4.9		nC
Turn-on delay time	td(on)	Vgs=-10V, Vds=-15V Rl=1.8Ω, Rgen=3Ω		7.1		ns
Turn-on rise time	tr			3.4		ns
Turn-off delay time	td(off)			18.9		ns
Turn-off fall time	tf			8.4		ns
Body diode reverse recovery time	trr	If=-8A, dl/dt=100A/µs		21.5	27.0	ns
Body diode reverse recovery charge	Qrr	If=-8A, dl/dt=100A/µs		12.5		nC

NOTE :

1. The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given applications depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80µs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25°C. The SOA curve provides a single pulse rating.



Single P-channel MOSFET

ELM14411AA-N

■ Typical electrical and thermal characteristics

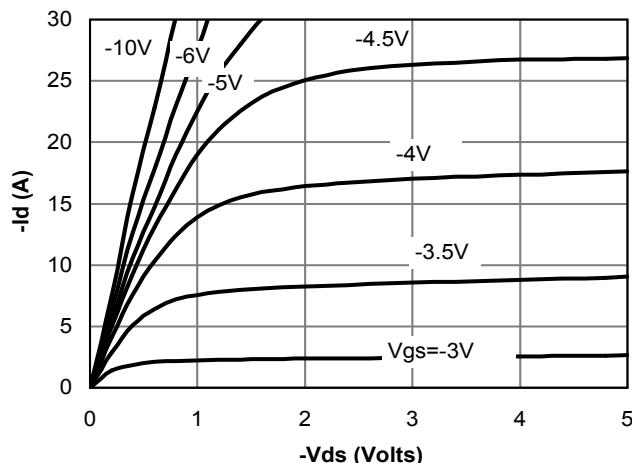


Fig 1: On-Region Characteristics

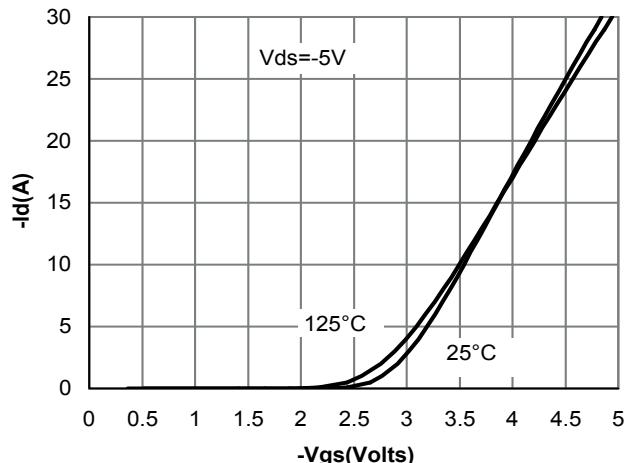


Figure 2: Transfer Characteristics

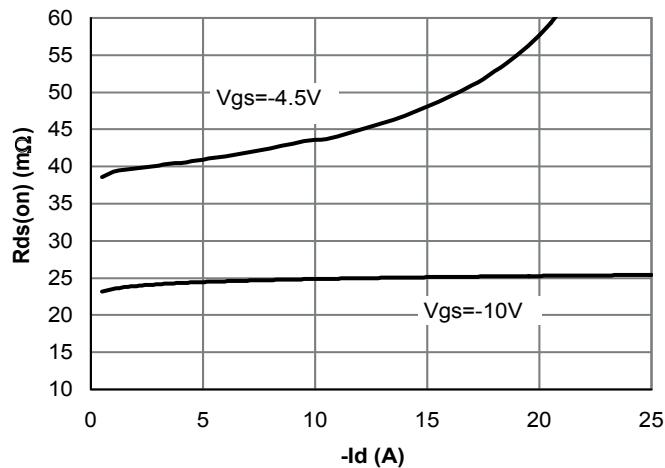


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

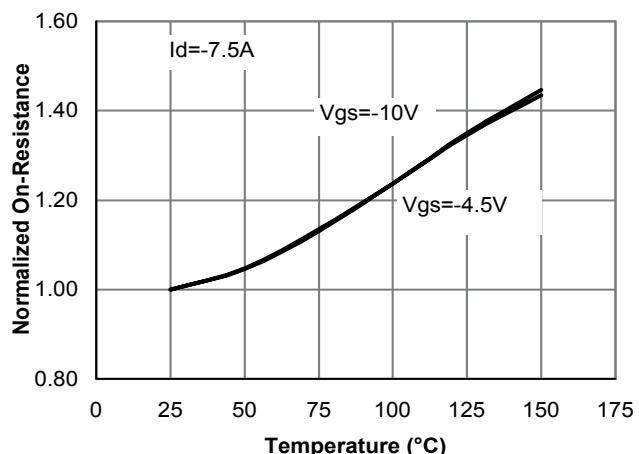


Figure 4: On-Resistance vs. Junction Temperature

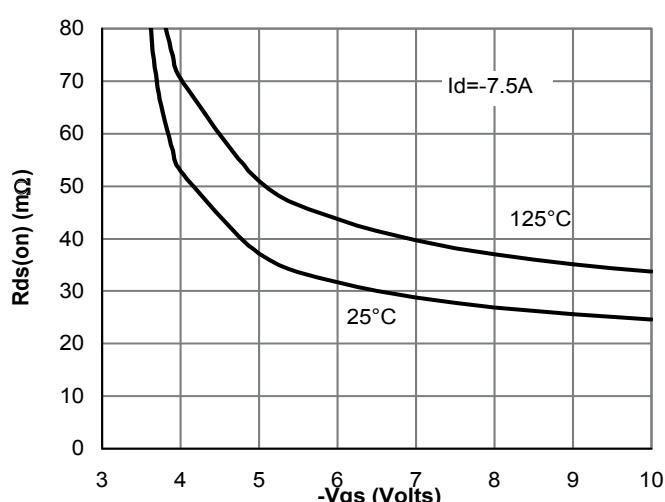


Figure 5: On-Resistance vs. Gate-Source Voltage

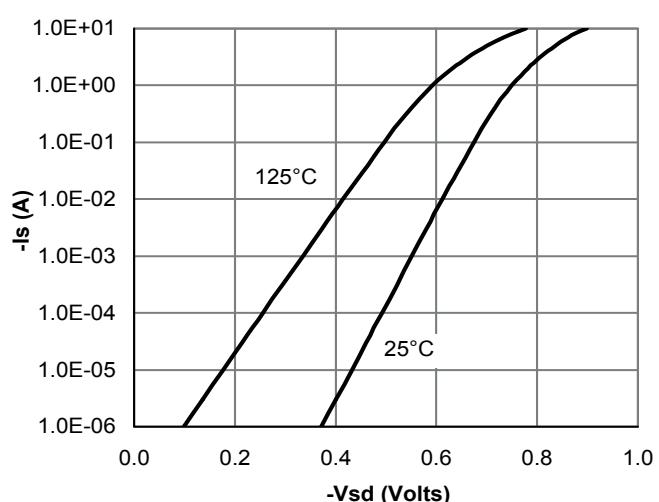


Figure 6: Body-Diode Characteristics

Single P-channel MOSFET

ELM14411AA-N

